

Title (en)  
Cooking device assembly

Title (de)  
Kochvorrichtungsanordnung

Title (fr)  
Agencement de dispositif de cuisson

Publication  
**EP 2028912 A3 20091014 (DE)**

Application  
**EP 08105057 A 20080818**

Priority  
ES 200702373 A 20070824

Abstract (en)  
[origin: EP2028912A2] The arrangement has a heating arrangement (34.1) of heating units, and a heat classification unit forming heating groups that are adapted to a selection position of a preparation dish. A power arrangement (38.1) of a power unit (26) produces heating power for the heating arrangement. A heat sink unit (46) forms heat receiving regions (56, 58) for receiving heat that is produced by the power arrangement. The heat sink unit is arranged below the heating arrangement in a base attachment position and arranged between the heating arrangement and the power arrangement.

IPC 8 full level  
**H05B 6/12** (2006.01); **H05B 6/42** (2006.01)

CPC (source: EP ES)  
**H05B 6/12** (2013.01 - ES); **H05B 6/1263** (2013.01 - EP); **H05B 2206/022** (2013.01 - EP); **H05B 2213/03** (2013.01 - EP)

Citation (search report)

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- [A] DE 10033361 A1 20020124 - WARTMANN THOMAS [DE]
- [A] DE 102004003126 A1 20050804 - EGO ELEKTRO GERAETEBAU GMBH [DE]
- [A] JP H01105489 A 19890421 - MATSUSHITA ELECTRIC IND CO LTD

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Designated contracting state (EPC)  
AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MT NL NO PL PT RO SE SI SK TR

Designated extension state (EPC)  
AL BA MK RS

DOCDB simple family (publication)  
**EP 2028912 A2 20090225; EP 2028912 A3 20091014**; ES 2321467 A1 20090605; ES 2321467 B1 20100304

DOCDB simple family (application)  
**EP 08105057 A 20080818**; ES 200702373 A 20070824